

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
80V	8.0mΩ@10V	95A

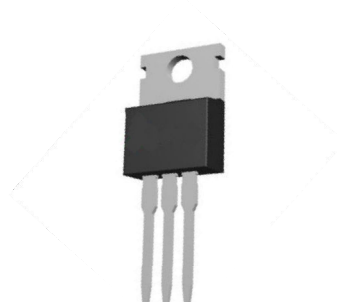
Feature

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

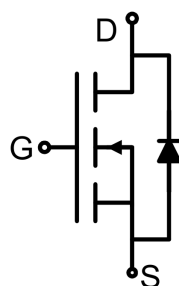
- Power switching application
- Hard switched and High frequency circuits
- Uninterruptible power supply

Package



TO-220AB

Circuit diagram



Marking



Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	80	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	95	A
Pulsed Drain Current	I_{DM}	320	A
Power Dissipation	P_D	170	W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.88	$^{\circ}C/W$
Single pulse avalanche energy	E_{AS}	529	mJ
Junction Temperature	T_J	150	$^{\circ}C$
Storage Temperature	T_{STG}	-55 ~ +150	$^{\circ}C$

Electrical characteristics (T_A=25 °C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =250μA	80			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =80V,V _{GS} = 0V			1	μA
Gate-body leakage current	I _{GSS}	V _{GS} =±20V, V _{DS} = 0V			±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2		4	V
Drain-source on-resistance ¹⁾	R _{DS(on)}	V _{GS} =10V, I _D =20A		6.6	8.0	mΩ
Forward transconductance ¹⁾	g _{FS}	V _{DS} =5V, I _D =20A		50		S
Dynamic characteristics ²⁾						
Input Capacitance	C _{iss}	V _{DS} =25V,V _{GS} =0V,f =1MHz		6800		pF
Output Capacitance	C _{oss}			353		
Reverse Transfer Capacitance	C _{rss}			261		
Total Gate Charge	Q _g	V _{DS} =40V,V _{GS} =10V,ID =50A		109		nC
Gate-Source Charge	Q _{gs}			35.1		
Gate-Drain Charge	Q _{gd}			25.8		
Turn-on delay time	t _{d(on)}	V _{DD} =40V,V _{GS} =10V, R _L =15Ω,R _{GEN} =2.5Ω		18		nS
Turn-on rise time	t _r			12		
Turn-off delay time	t _{d(off)}			56		
Turn-off fall time	t _f			15		
Source-Drain Diode characteristics						
Diode Forward Current ¹⁾	I _S				95	A
Diode Forward voltage	V _{DS}	V _{GS} =0V, I _S =95A			1.2	V
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF =100A di/dt = 100A/μs ¹⁾			37	nS
Reverse Recovery Charge	Q _{rr}				58	nC

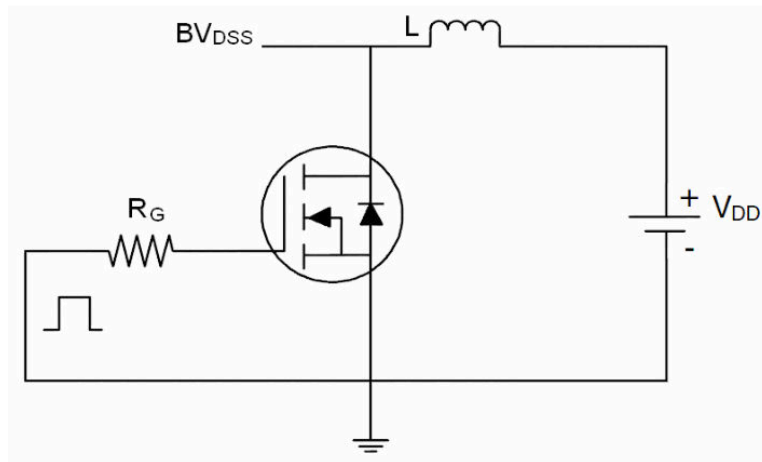
Notes:

1) Pulse Test: Pulse Width < 300 μs , Duty Cycle $\leq 2\%$.

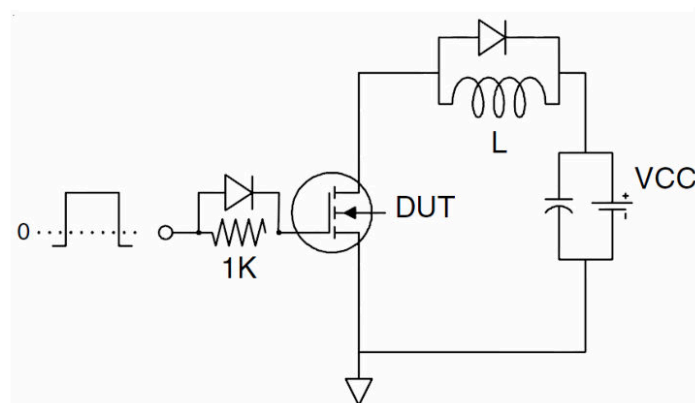
2) Guaranteed by design, not subject to production testing.

Test Circuit

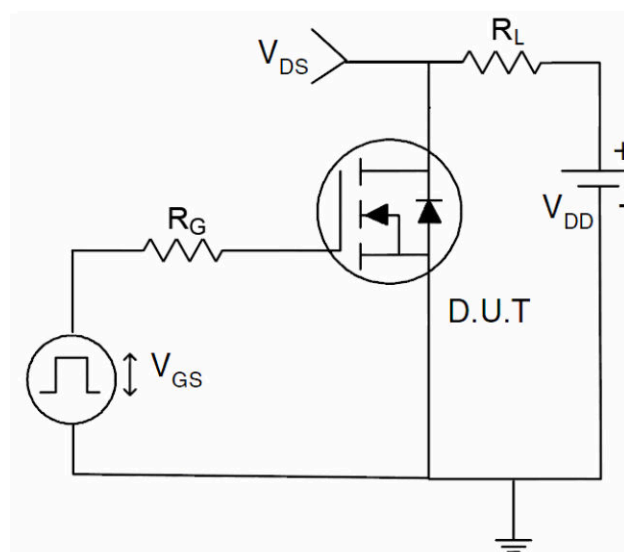
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



Typical Characteristics

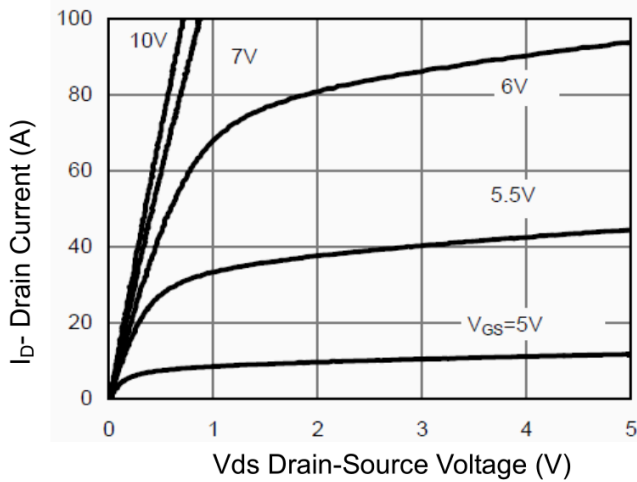


Figure 1 Output Characteristics

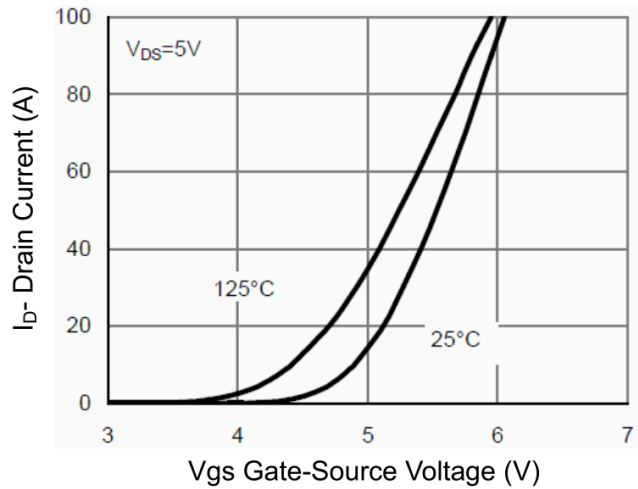


Figure 2 Transfer Characteristics

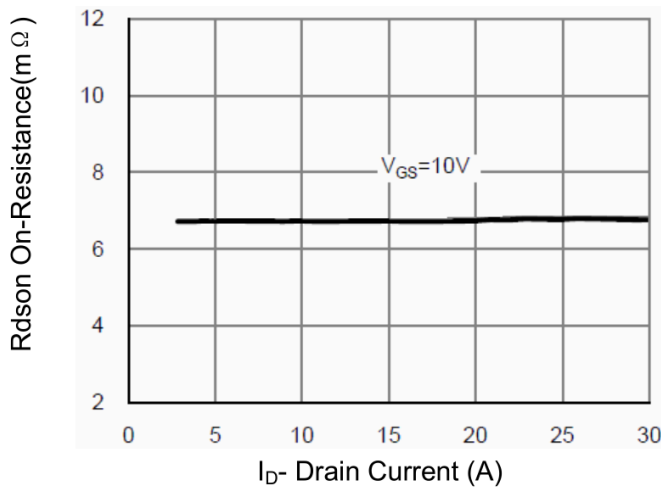


Figure 3 Rdson- Drain Current

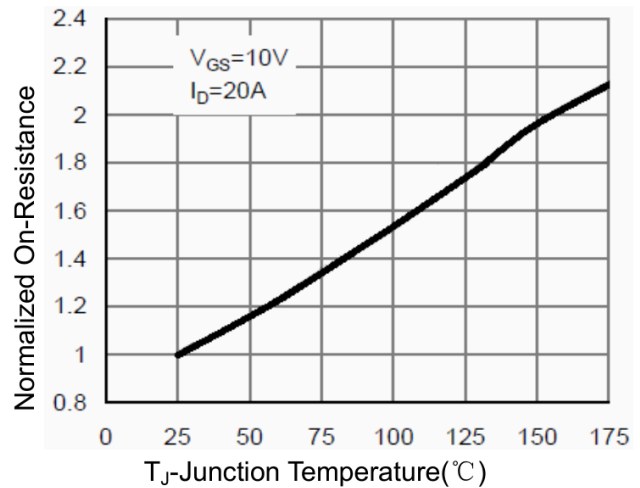


Figure 4 Rdson-Junction Temperature

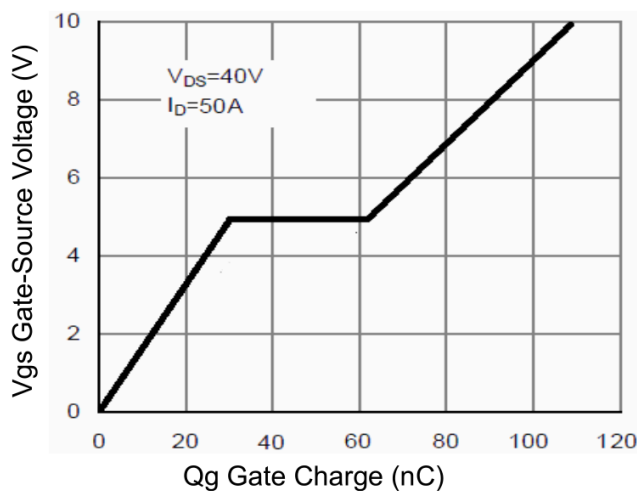


Figure 5 Gate Charge

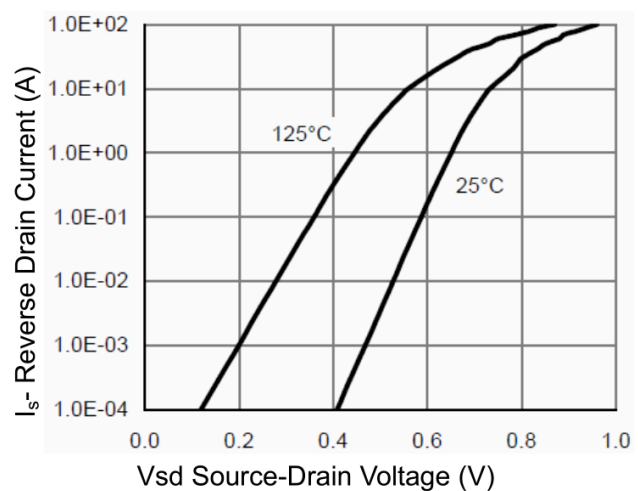


Figure 6 Source- Drain Diode Forward

Typical Characteristics

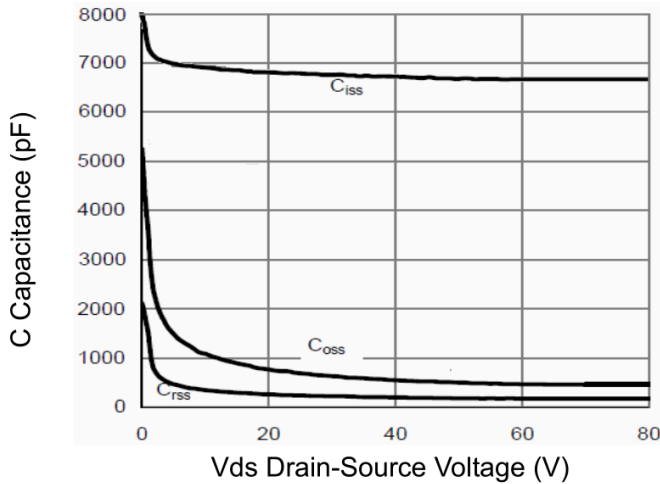


Figure 7 Capacitance vs Vds

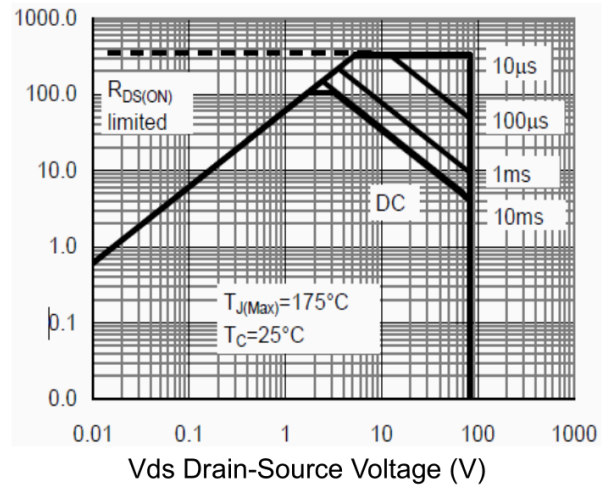


Figure 8 Safe Operation Area

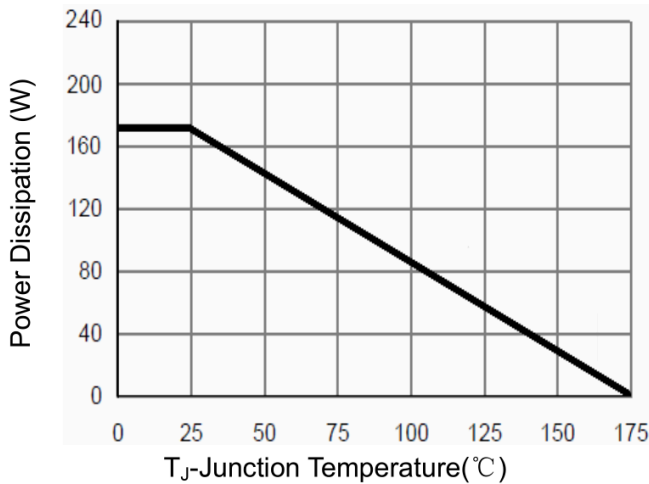


Figure 9 Power De-rating

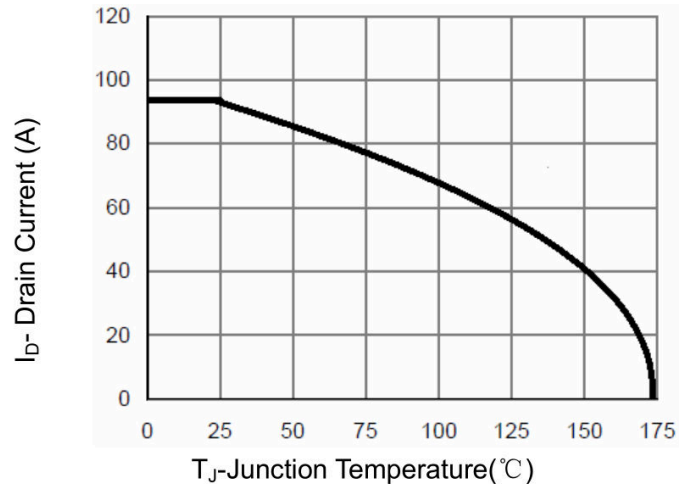


Figure 10 ID Current De-rating

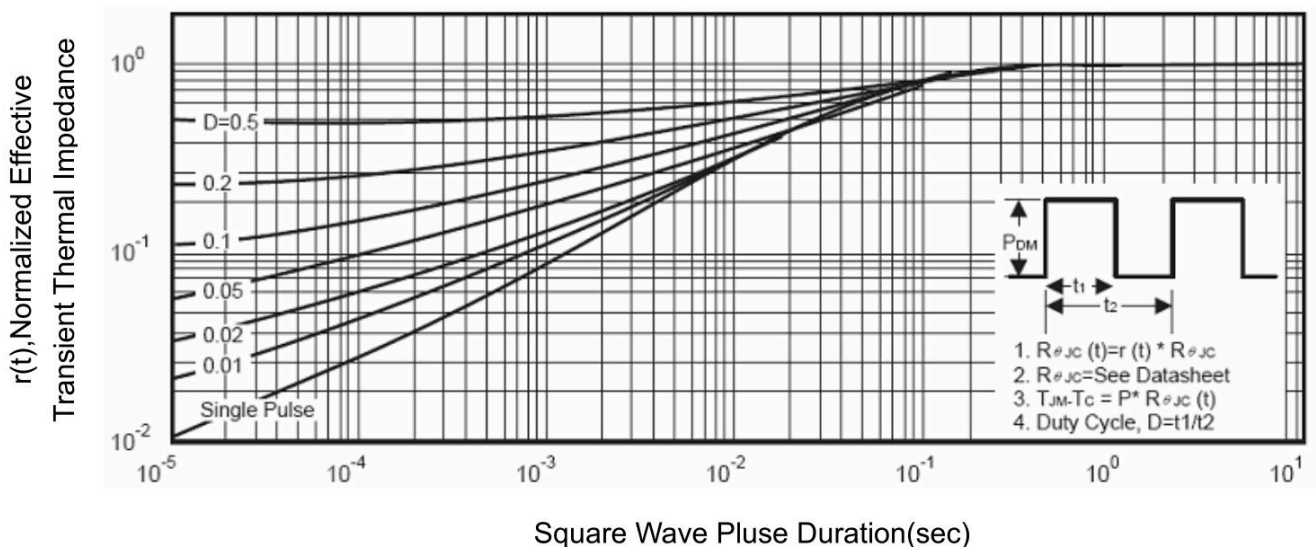
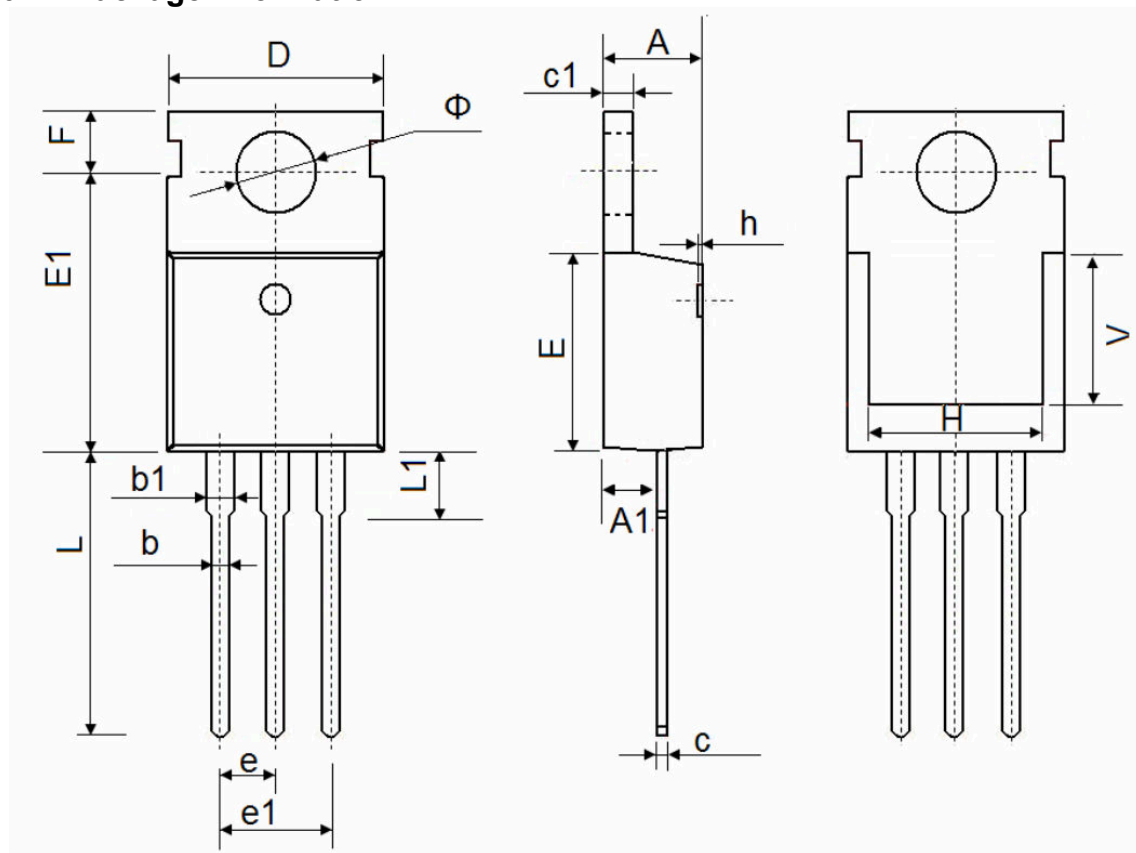


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-220AB Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.9500	9.750	0.352	0.384
E1	12.650	12.950	0.498	0.510
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	7.500 REF.		0.295 REF.	
Φ	3.400	3.800	0.134	0.150